



### RS720Q-E11-RS8U

# **Great Scalability and High Performance Computing (HPC) Multi-Node Server with Direct to Chip Liquid Cooling Solution**











ASUS RS720Q-E11-RS8U is the ideal multi-node server powered by 4th Gen Intel® Xeon Scalable processors, with each node supporting up to 16 DIMM, two PCIe® 5.0 slot and two M.2, and a total of eight NVMe/SAS/SATA drives.

#### **FEATURE**

- Powered by dual-socket 4th Gen Intel Scalable processors with DDR4 Memory up to 4800MHz
- Multi-Node Server with Immersion Cooling Solution
- Two PCIe 5.0 x16 slot module per node
- 8 x 2.5" Hot-swap Drive Bays support 8 x NVMe
- 3000W 80 Plus® Titanium power supplies
- Onboard ASUS ASMB11-iKVM
- ASPEED AST2600 controller

#### 4<sup>th</sup> Gen Intel Xeon Scalable processors

The RS720Q-E11-RS8U is built with the latest Intel® Xeon® Processor Scalable Family with 16 DDR5 Memory up to 4800MHz, and designed for the demand of high scalability, high density computing, and wide range of existing and emerging workloads.

#### **Direct to Chip Liquid Cooling Solution**

ASUS Direct to Chip Liquid cooling is another highly-effective solution from ASUS. This technique offers more advantages on PUE and encompasses higher-density servers. However, it also demands more space, and may require retooling of the data-center infrastructure. But Direct to Chip Liquid cooling can control temperatures more rapidly, efficiently and cost-effectively than traditional methods. For users of supercomputers in particular, immersion cooling is the preferred option.

#### PCIe 5.0 Ready

PCI Express® (PCIe®) 5.0 delivers 16 GT/s bandwidth, which is double the speed of PCIe 4.0, offering lower power consumption, better lane scalability and backwards compatibility.

#### **Enhanced Security**

PFR FPGA as the platform Root-of-Trust solution for firmware resiliency Trusted Platform Module 2.0 (TPM 2.0) to secure hardware through integrated cryptographic keys and offer regular firmware update for vulnerabilities.





## RS720Q-E11-RS8U Processor Support

**SPECIFICATION** 

2 x Socket P+ (LGA 4189) per Node

3rd Gen Intel® Xeon® processor Scalable family (Up to 270W)

UPI 11.2 GT/s

Core Logic		Intel® C741 PCH
Memory	Total Slots	16 (8-channel per CPU, 8 DIMM per CPU)
	Capacity	Maximum up to 8192GB per Node
	Memory Type	DDR5 4800 RDIMM/RDIMM 3DS (1DIMM per Channel) 512GB, 256GB, 128GB Intel® Optane™ persistent memory 300 series (Crow Pass) *Refer to Asus server AVL for the latest update
	Memory Size	64GB, 32GB, 16GB RDIMM 256GB, 128GB RDIMM 3DS * Refer to www.asus.com/support for more information
Expansion Slots	Total PCI/PCI-X/PCI-E/PIKE Slots	Per Node:
	Slot Type	2 x PCI-E x16 (Gen5 x16 link), HHHL (CPU1) 2 x M.2 PICe Gen4 x4 link or SATA (CPU1)
Disk Controller	SATA Controller	The Same as SAS Controller
	SAS Controller	Per Node: Broadcom SAS3008 (Support RAID 0, 1) - 2 x SAS 12Gb/s ports or - 2 x SATA 6Gb/s ports
	NVMe Controller	The Same as SAS Controller
Storage Bays	I = internal A or S will be hot-swappable	8 x 2.5" Hot-swap Storage Bays (NVMe Supported)
Networking	LAN	Per Node: 2 x Intel X710-AT2 Gigabit LAN Controller 1 x Management Port
Graphic	VGA	Aspeed AST2600 64MB
Front I/O Ports		N/A
Rear I/O Ports		Per Node: 2 x USB 3.1 Ports 1 x VGA Port 1 x RJ-45 GbE LAN Ports 1 x RJ-45 Management Port
Switch/LED		Per Node: Rear:  1 x Power Switch/LED  1 x Q-Code/Port 80 LED Front:  1 x Power Switch/LED  1 x Location Switch/LED  1 x Message LED  2 x LAN LED
OS Support		Please find the latest OS support from http://www.asus.com/
Management Solution	Software	ASUS Control Center (Classic)
	Out of Band Remote Management	On-Board ASM10-iKVM for KVM-over-IP
Dimension		800mm x 444mm x 88mm (2U) 31.5" x 17.48" x 3.46"
Net Weight Kg (CPU, DRAM & HDD not included)		35.5 Kg
Gross Weight Kg (CPU, DRAM & HDE	O not included, Packing included)	41.5 Kg
Power Supply (following different configuration by region)		1+1 Redundant 3000W 80 PLUS Titanium Power Supply Rating: 220-240 Vac, 15.5A (x2), 50-60Hz, Class I
Environment		Operation temperature: $10^{\circ}\text{C} \sim 35^{\circ}\text{C}$ Non operation temperature: $-40^{\circ}\text{C} \sim 70^{\circ}\text{C}$ Non operation humidity: $20\% \sim 90\%$ (Non condensing)